

View Online at <https://aerobasegroup.com/nsn/5910-01-128-1453>

Body Style:

Chip type

Reliability Indicator:

Established

Reliability Failure Rate Level In Percent:

0.0100

Terminal Length:

0.020 inches

Body Length:

0.180 inches

Body Width:

0.125 inches

Body Height:

Between 0.020 inches and 0.080 inches

Center To Center Distance Between Terminals Parallel To Length:

0.140 inches

Schematic Diagram Designator:

No common or grounded electrode (s)

Insulation Resistance At Maximum Operating Temp:

1000.0 megohms

Capacitance Value Per Section:

3300.000 picofarads single section

Nonderated Operating Temp:

Between -55.0 degrees celsius and 125.0 degrees celsius

Temperature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:

0.0 single section

Nonderated Continuous Voltage Rating And Type Per Section:

200.0 dc single section

Tolerance Of Temperature Coefficient Per Section In Ppm Per Deg Celsius:

-30.0/+30.0 single section

Tolerance Range Per Section:

-5.00/+5.00 percent single section

Case Material:

Ceramic

Insulation Resistance At Reference Temp:

100000.0 megohms

Dissipation Factor At Reference Temperature In Percent:

0.1500

Terminal Surface Treatment:

Solder

Test Data Document:

81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

Terminal Type And Quantity:

2 bonding pad

Specification Data:

81349-mil-c-55681/1 government specification

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

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